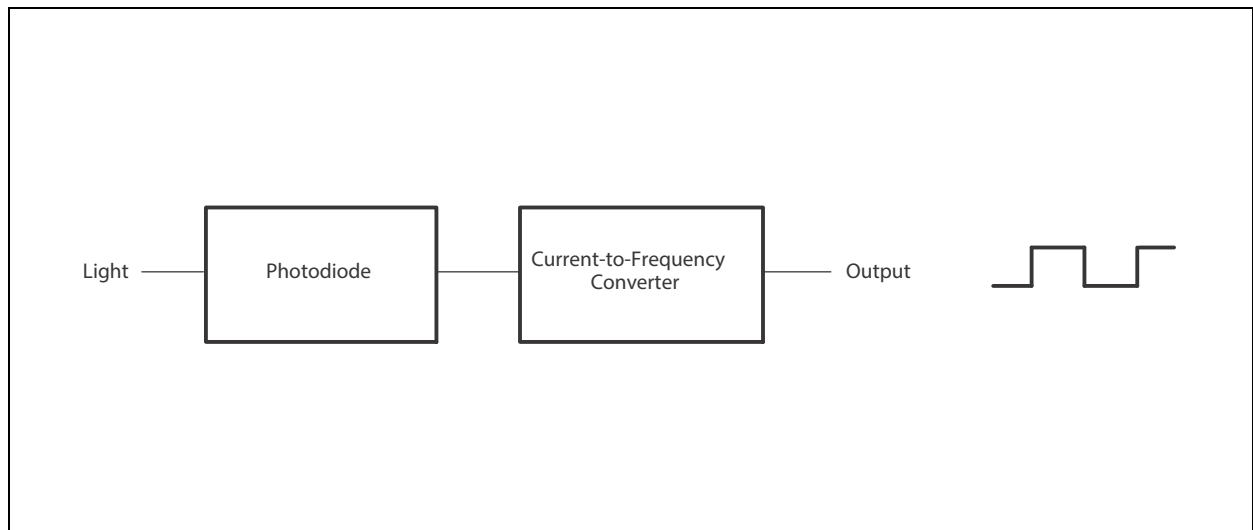


Functional Block Diagram

The functional blocks of this device are shown below:

Figure 2:
TSL237 Block Diagram



Pin Assignment

The TSL237 pin assignments are described below.

Figure 3:
Pin Diagram

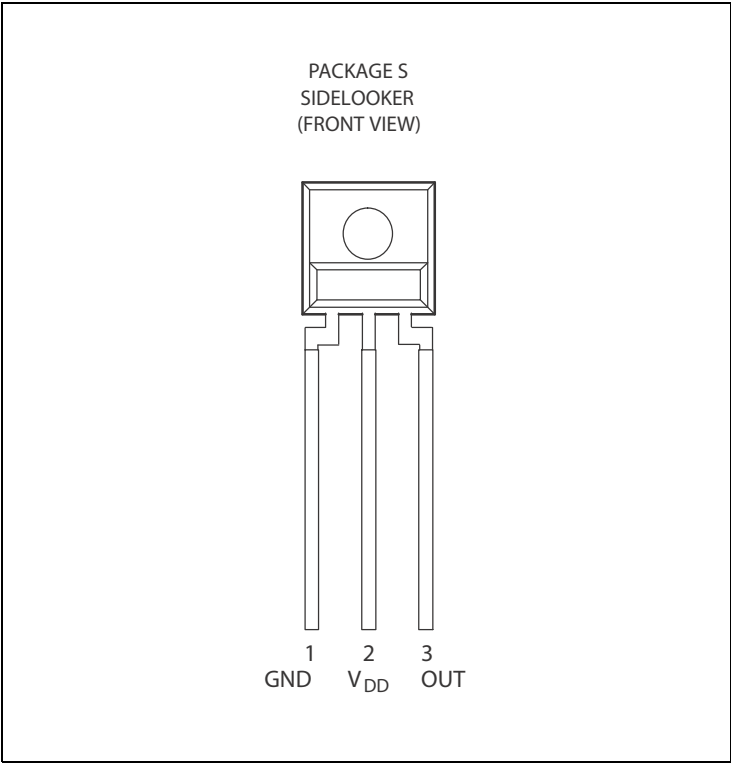


Figure 4:
Terminal Functions

Terminal		Type	Description
No.	Name		
1	GND		Power supply ground (substrate). All voltages are referenced to GND.
2	V _{DD}		Supply voltage
3	OUT	O	Output frequency

Absolute Maximum Ratings

Stresses beyond those listed under [Absolute Maximum Ratings](#) may cause permanent damage to the device. These are stress ratings only. Functional operation of the device at these or any other conditions beyond those indicated under [Electrical Characteristics](#) is not implied. Exposure to absolute maximum rating conditions for extended periods may affect device reliability.

Figure 5:
Absolute Maximum Ratings Over Operating Free-Air Temperature Range (unless otherwise noted)

Symbol	Parameter	Min	Max	Unit
V_{DD}	Supply voltage ⁽¹⁾		6	V
T_A	Operating free-air temperature range ⁽²⁾	-40	85	°C
T_{STRG}	Storage temperature range ⁽²⁾	-40	85	°C
	Lead temperature 1.6mm (1/16 inch) from case for 10 seconds (S Package)		260	°C

Note(s):

1. All voltage values are with respect to GND.
2. Long-term storage or operation above 70°C could cause package yellowing that will lower the sensitivity to wavelengths < 500nm.

Electrical Characteristics

All limits are guaranteed. The parameters with min and max values are guaranteed with production tests or SQC (Statistical Quality Control) methods.

Figure 6:
Recommended Operating Conditions

Symbol	Parameter	Min	Nom	Max	Unit
V_{DD}	Supply voltage	2.7	5	5.5	V
T_A	Operating free-air temperature	-40		70	°C

Figure 7:
Electrical Characteristics at $V_{DD} = 5V$, $T_A = 25^\circ C$ (unless otherwise noted)

Symbol	Parameter	Test Conditions	Min	Typ	Max	Units
V_{OH}	High-level output voltage	$I_{OH} = -1mA$	4	4.5		V
V_{OL}	Low-level output voltage	$I_{OL} = 1mA$		0.25	0.4	V
I_{DD}	Supply current			2	3	mA
	Full-scale frequency ⁽¹⁾		500		1000	kHz
	Temperature coefficient of responsivity	Wavelength < 600nm, $f_O = 50kHz$		±200		ppm/°C
k_{SYS}	Supply-voltage sensitivity	$V_{DD} = 5V \pm 10\%$		±0.5		%/V

Note(s):

1. Full-scale frequency is the maximum operating frequency of the device without saturation.

Figure 8:
Operating Characteristics at $V_{DD} = 5V$, $T_A = 25^\circ C$, $\lambda_p = 524nm$ (unless otherwise noted)

Symbol	Parameter	Test Conditions	Min	Typ	Max	Units
f_O	Output frequency	$E_e = 21.8\mu W/cm^2$	40	50	60	kHz
f_D	Dark frequency	$E_e = 0\mu W/cm^2$	0	0.1		Hz
		$E_e = 0\mu W/cm^2$, $T_A = 50^\circ C$	0		2	Hz
R_e	Irradiance responsivity			2.3		kHz/($\mu W/cm^2$)
	Nonlinearity ⁽¹⁾	$f_O = 0kHz$ to $10kHz$		$\pm 1\%$		%F.S.
	Step response to full-scale step input		1 pulse of new frequency plus $1\mu s$			

Note(s):

1. Nonlinearity is defined as the deviation of f_O from a straight line between zero and full scale, expressed as a percent of full scale.

Typical Operating Characteristics

Figure 9:
Output Frequency vs. Irradiance

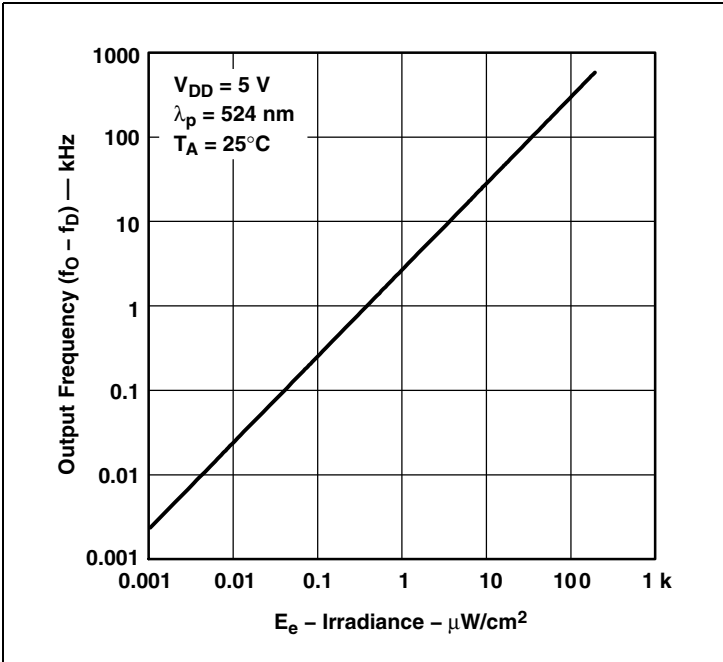


Figure 10:
Photodiode Spectral Responsivity

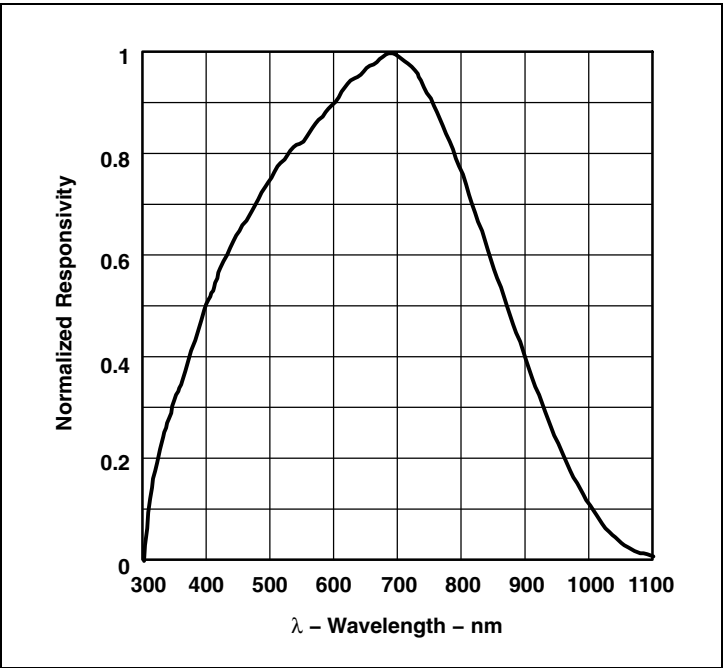


Figure 11:
Supply Current vs. Free-Air Temperature

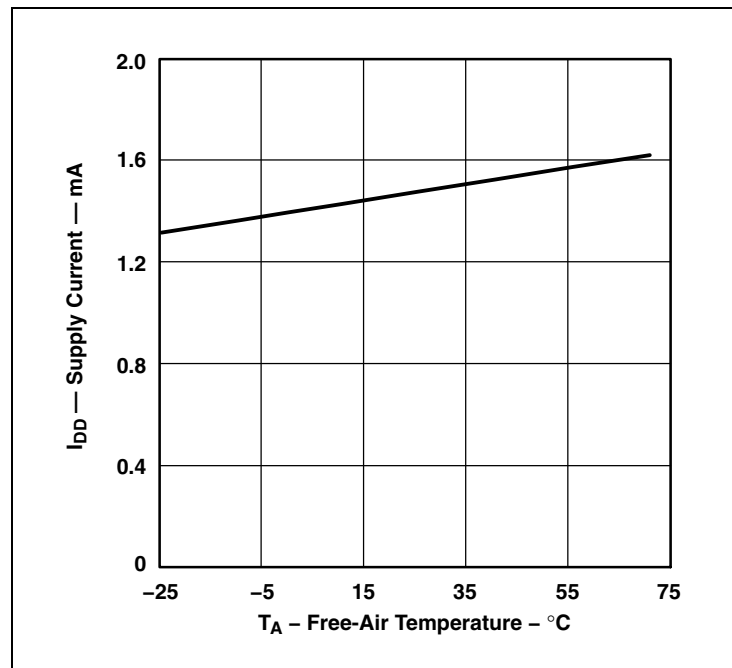


Figure 12:
Output Frequency vs. Free-Air Temperature

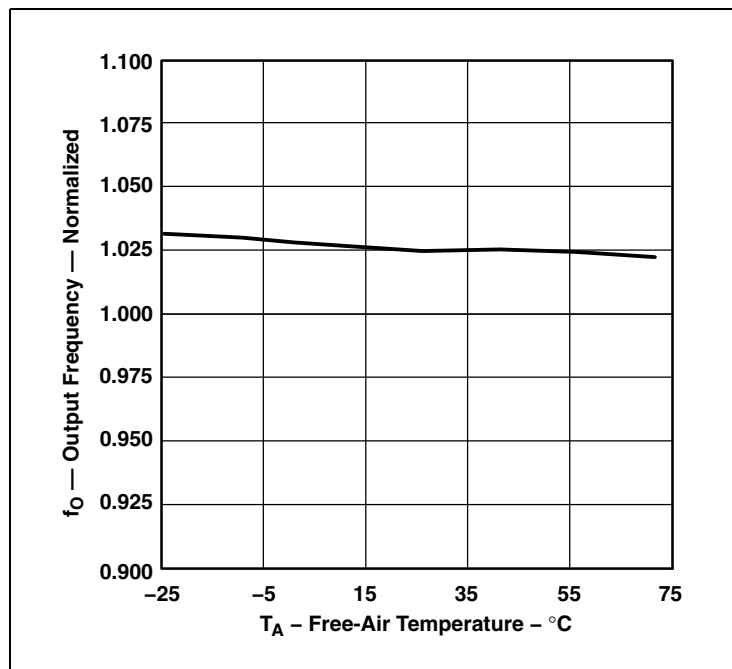


Figure 13:
Output Frequency vs. Vertical Angular Displacement

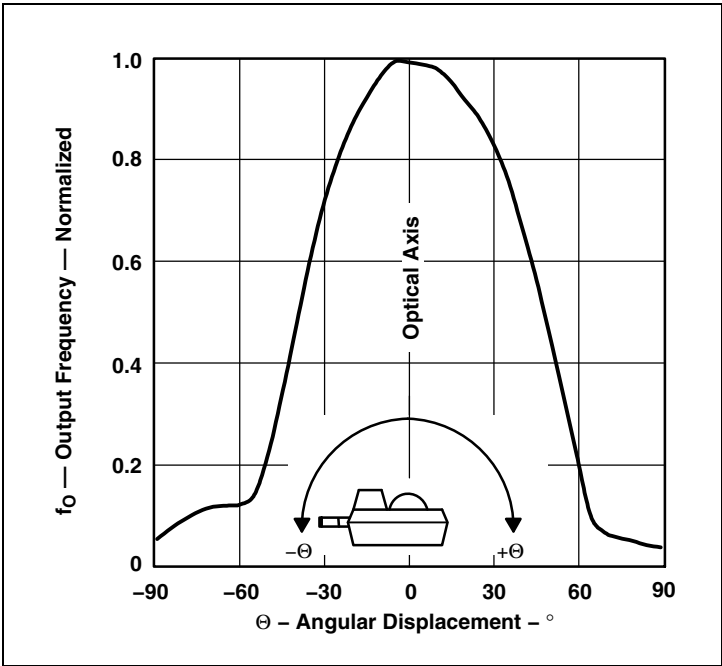


Figure 14:
Output Frequency vs. Horizontal Angular Displacement

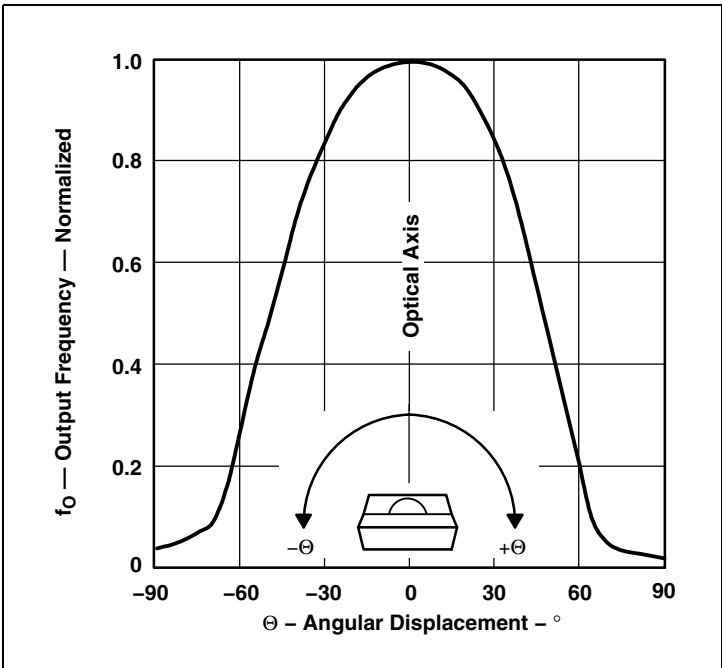
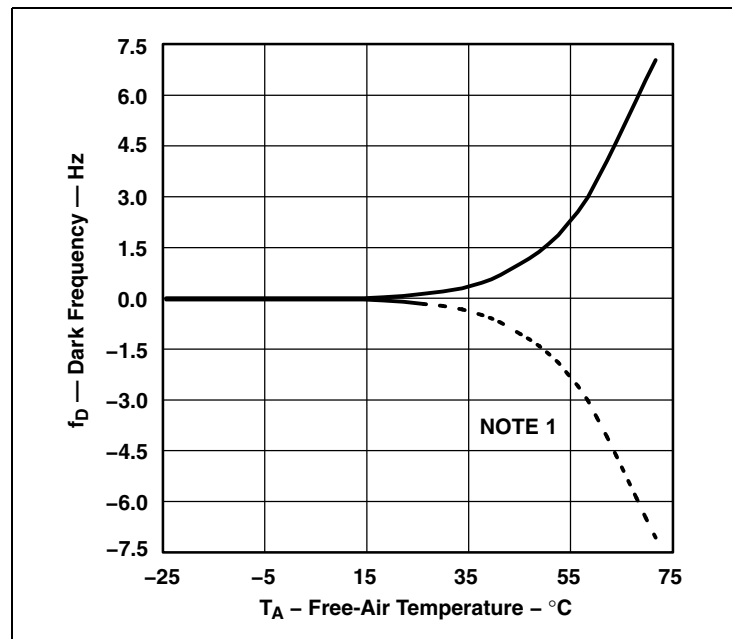


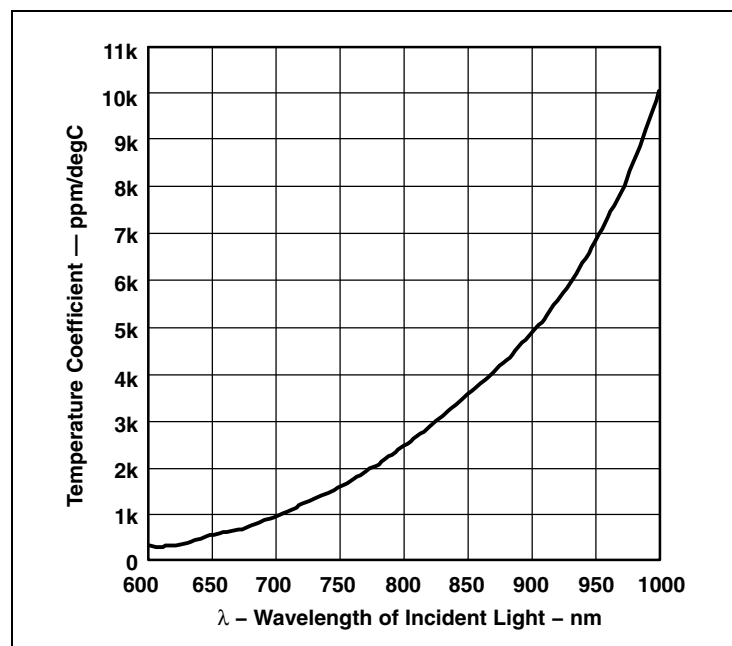
Figure 15:
Dark Frequency vs. Free-Air Temperature



Note(s):

- Internal offsets that result in dark frequency can be both positive and negative. The dashed line represents the case of negative offset in which an equivalent amount of light signal is required to obtain a non-zero output frequency.

Figure 16:
Photodiode Responsivity Temperature Coefficient vs. Wavelength of Incident Light

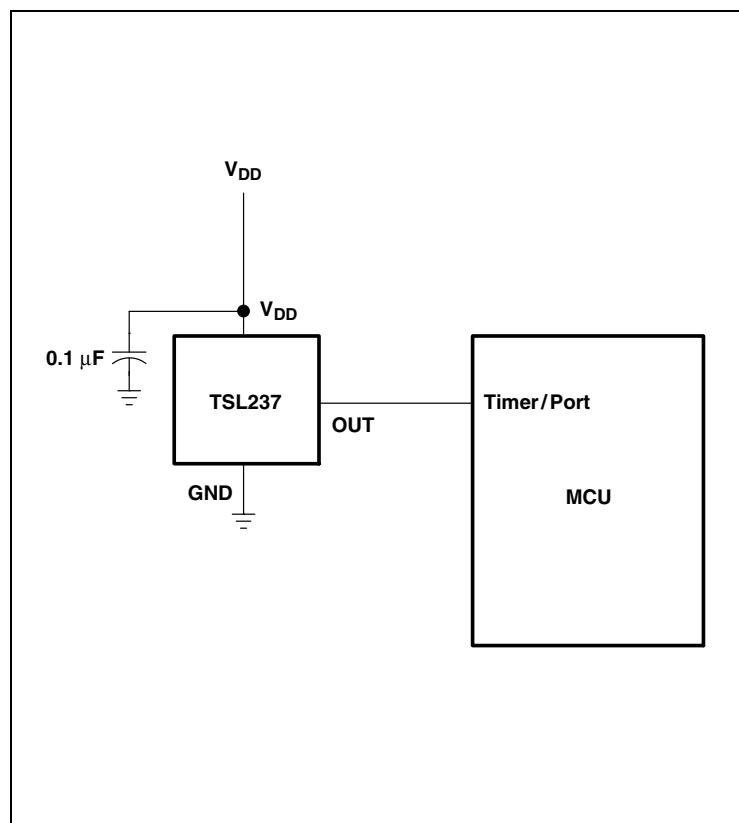


Application Information

Power-Supply Considerations

Power-supply lines must be decoupled by a 0.01 μF to 0.1 μF capacitor with short leads placed close to the TSL237 (Figure 17). A low-noise power supply is required to minimize jitter on output pulse.

Figure 17:
Typical TSL237 Interface to a Microcontroller



Device Operational Details

The frequency at the output pin (OUT) is given by:

$$(EQ1) \quad f_O = f_D + (R_e)(E_e)$$

where:

f_O is the output frequency

f_D is the output frequency for dark condition ($E_e = 0$)

R_e is the device responsivity for a given wavelength of light given in $\text{kHz}/(\mu\text{W}/\text{cm}^2)$

E_e is the incident irradiance in $\mu\text{W}/\text{cm}^2$

f_D is a constant error term in the output frequency calculation resulting from leakage currents, and is independent of light intensity.

The TSL237 die is trimmed to minimize the magnitude of this dark frequency component so that it can be neglected in the transfer function calculation. In many applications, measurement of the actual dark frequency may be impractical due to measurement times ranging from several seconds to several minutes, and the fact that some devices may never transition (zero dark frequency).

Output Interface

The output of the device is designed to drive a CMOS logic input over short distances. If lines greater than 12 inches in length are used on the output, a buffer or line driver is recommended.

Measuring the Frequency

The choice of interface and measurement technique depends on the desired resolution and data-acquisition rate. For maximum data-acquisition rate, period-measurement techniques are used.

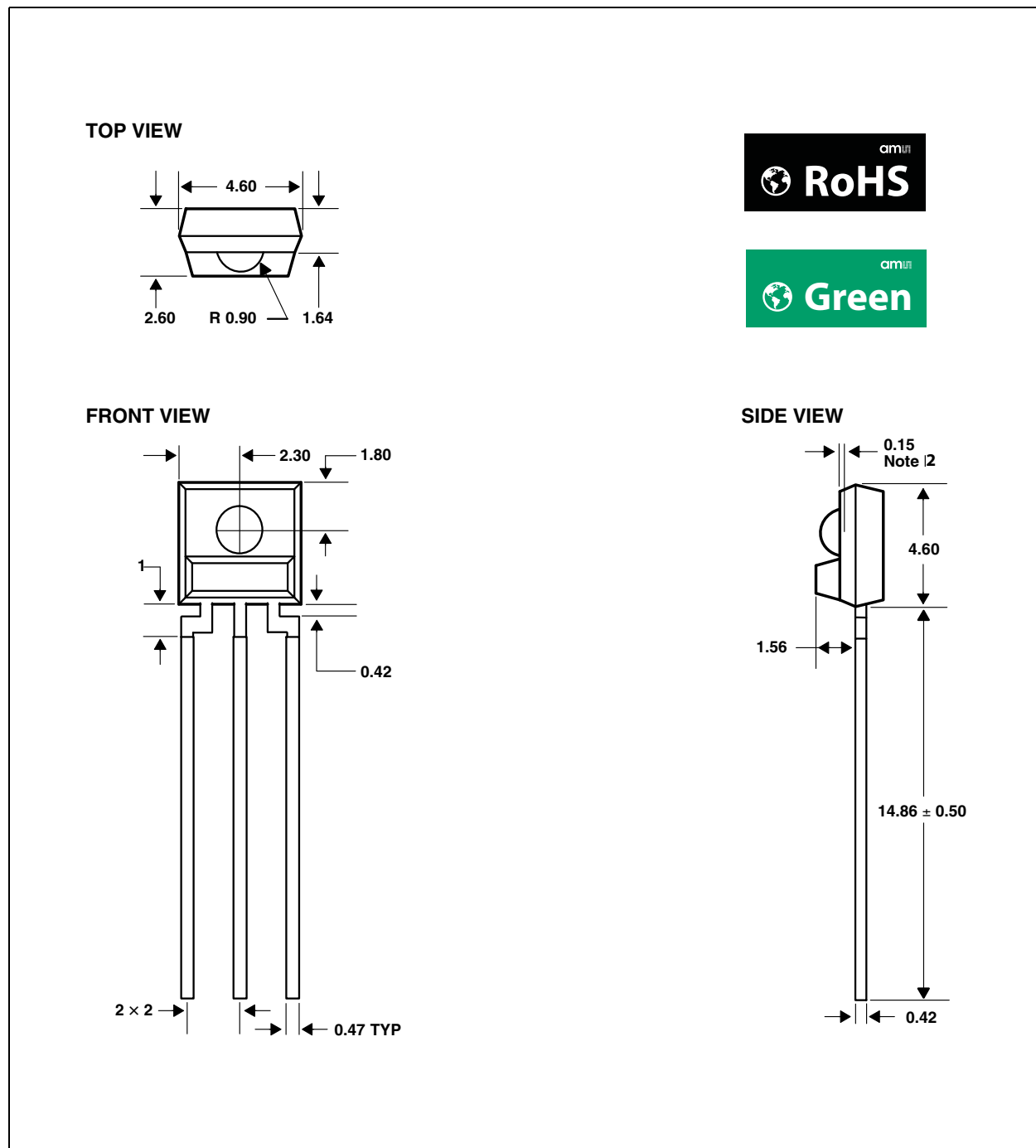
Period measurement requires the use of a fast reference clock with available resolution directly related to the reference-clock rate. The technique is employed to measure rapidly varying light levels or to make a fast measurement of a constant light source.

Maximum resolution and accuracy may be obtained using frequency-measurement, pulse-accumulation, or integration techniques. Frequency measurements provide the added benefit of averaging out random- or high-frequency variations (jitter) resulting from noise in the light signal. Resolution is limited mainly by available counter registers and allowable measurement time. Frequency measurement is well suited for slowly varying or constant light levels and for reading average light levels over short periods of time. Integration, the accumulation of pulses over a very long period of time, can be used to measure exposure - the amount of light present in an area over a given time period.

Mechanical Information

The device is supplied in a clear plastic three-lead through-hole package.

Figure 18:
Package S - Plastic Single-In-Line Side-Looker Package Configuration



Note(s):

1. All linear dimensions are in millimeters; tolerance is $\pm 0.25\text{mm}$ unless otherwise stated.
2. Dimension is to center of lens arc, which is located below the package face.
3. The integrated photodiode active area is typically 0.92mm^2 in size and is located in the center of the lens and 0.97mm below the top of the lens surface.
4. Index of refraction of clear plastic is 1.55.
5. Lead finish for TSL237-LF: solder dipped, 100% Sn.
6. This drawing is subject to change without notice.

Ordering & Contact Information

Figure 19:
Ordering Information

Ordering Code	Device	T _A	Package-Leads	Package Designator
TSL237S-LF	TSL237	-40°C to 70°C	3-lead Sidelooker - Lead (Pb) Free	S

Buy our products or get free samples online at:

www.ams.com/ICdirect

Technical Support is available at:

www.ams.com/Technical-Support

Provide feedback about this document at:

www.ams.com/Document-Feedback

For further information and requests, e-mail us at:

ams_sales@ams.com

For sales offices, distributors and representatives, please visit:

www.ams.com/contact

Headquarters

ams AG

Tobelbader Strasse 30

8141 Premstaetten

Austria, Europe

Tel: +43 (0) 3136 500 0

Website: www.ams.com

RoHS Compliant & ams Green Statement

RoHS: The term RoHS compliant means that ams AG products fully comply with current RoHS directives. Our semiconductor products do not contain any chemicals for all 6 substance categories, including the requirement that lead not exceed 0.1% by weight in homogeneous materials. Where designed to be soldered at high temperatures, RoHS compliant products are suitable for use in specified lead-free processes.

ams Green (RoHS compliant and no Sb/Br): ams Green defines that in addition to RoHS compliance, our products are free of Bromine (Br) and Antimony (Sb) based flame retardants (Br or Sb do not exceed 0.1% by weight in homogeneous material).

Important Information: The information provided in this statement represents ams AG knowledge and belief as of the date that it is provided. ams AG bases its knowledge and belief on information provided by third parties, and makes no representation or warranty as to the accuracy of such information. Efforts are underway to better integrate information from third parties. ams AG has taken and continues to take reasonable steps to provide representative and accurate information but may not have conducted destructive testing or chemical analysis on incoming materials and chemicals. ams AG and ams AG suppliers consider certain information to be proprietary, and thus CAS numbers and other limited information may not be available for release.

Copyrights & Disclaimer

Copyright ams AG, Tobelbader Strasse 30, 8141 Premstaetten, Austria-Europe. Trademarks Registered. All rights reserved. The material herein may not be reproduced, adapted, merged, translated, stored, or used without the prior written consent of the copyright owner.

Devices sold by ams AG are covered by the warranty and patent indemnification provisions appearing in its General Terms of Trade. ams AG makes no warranty, express, statutory, implied, or by description regarding the information set forth herein. ams AG reserves the right to change specifications and prices at any time and without notice. Therefore, prior to designing this product into a system, it is necessary to check with ams AG for current information. This product is intended for use in commercial applications. Applications requiring extended temperature range, unusual environmental requirements, or high reliability applications, such as military, medical life-support or life-sustaining equipment are specifically not recommended without additional processing by ams AG for each application. This product is provided by ams AG "AS IS" and any express or implied warranties, including, but not limited to the implied warranties of merchantability and fitness for a particular purpose are disclaimed.

ams AG shall not be liable to recipient or any third party for any damages, including but not limited to personal injury, property damage, loss of profits, loss of use, interruption of business or indirect, special, incidental or consequential damages, of any kind, in connection with or arising out of the furnishing, performance or use of the technical data herein. No obligation or liability to recipient or any third party shall arise or flow out of ams AG rendering of technical or other services.

Document Status

Document Status	Product Status	Definition
Product Preview	Pre-Development	Information in this datasheet is based on product ideas in the planning phase of development. All specifications are design goals without any warranty and are subject to change without notice
Preliminary Datasheet	Pre-Production	Information in this datasheet is based on products in the design, validation or qualification phase of development. The performance and parameters shown in this document are preliminary without any warranty and are subject to change without notice
Datasheet	Production	Information in this datasheet is based on products in ramp-up to full production or full production which conform to specifications in accordance with the terms of ams AG standard warranty as given in the General Terms of Trade
Datasheet (discontinued)	Discontinued	Information in this datasheet is based on products which conform to specifications in accordance with the terms of ams AG standard warranty as given in the General Terms of Trade, but these products have been superseded and should not be used for new designs

Revision Information

Changes from 1-00 (2016-Jul-22) to current revision 1-01 (2018-Mar-27)	Page
Removed all instances of TSL237SM from datasheet	

Note(s):

1. Page and figure numbers for the previous version may differ from page and figure numbers in the current revision.
2. Correction of typographical errors is not explicitly mentioned.

Content Guide

1	General Description
1	Key Benefits & Features
2	Functional Block Diagram
3	Pin Assignment
4	Absolute Maximum Ratings
5	Electrical Characteristics
7	Typical Operating Characteristics
11	Application Information
11	Power-Supply Considerations
11	Device Operational Details
12	Output Interface
12	Measuring the Frequency
13	Mechanical Information
14	Ordering & Contact Information
15	RoHS Compliant & ams Green Statement
16	Copyrights & Disclaimer
17	Document Status
18	Revision Information